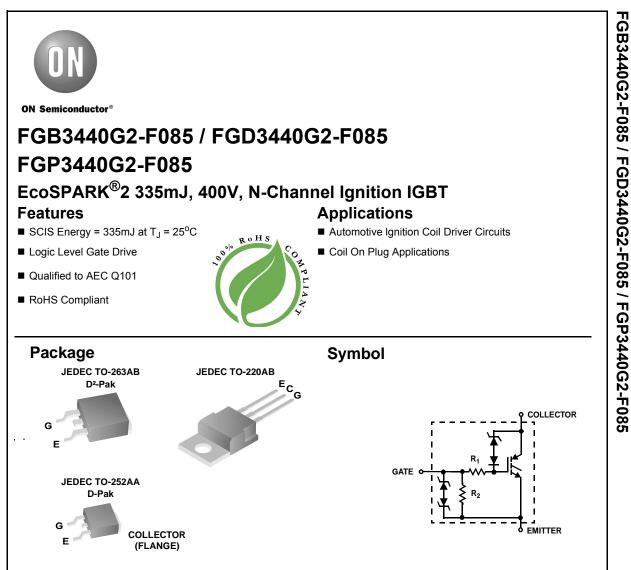
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Device Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
BV _{CER}	Collector to Emitter Breakdown Voltage (I _C = 1mA)	400	V
BV _{ECS}	Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10mA)	28	V
E _{SCIS25}	Self Clamping Inductive Switching Energy (Note 1)	335	mJ
E _{SCIS150}	Self Clamping Inductive Switching Energy (Note 2)	195	mJ
I _{C25}	Collector Current Continuous, at V _{GE} = 4.0V, T _C = 25°C	26.9	Α
I _{C110}	Collector Current Continuous, at V _{GE} = 4.0V, T _C = 110°C	25	Α
V _{GEM}	Gate to Emitter Voltage Continuous	±10	V
р	Power Dissipation Total, at T _C = 25°C	166	W
P _D	Power Dissipation Derating, for T _C > 25°C	1.1	W/ºC
ТJ	Operating Junction Temperature Range	-40 to +175	°C
T _{STG}	Storage Junction Temperature Range	-40 to +175	°C
ΤL	Max. Lead Temp. for Soldering (Leads at 1.6mm from case for 10s)	300	°C
T _{PKG}	Max. Lead Temp. for Soldering (Package Body for 10s)	260	°C
ESD	Electrostatic Discharge Voltage at100pF, 1500 Ω	4	kV

Packa	ge Mark	ing and Ordering	Information								
Device Marking Device			Package Reel Size Tap		Tape Wi	e Width		Quantity			
FGB	GB3440G2 FGB3440G2-F085		TO-263AB	330	mm	24mm	24mm		800		
FGD	3440G2	FGD3440G2-F085	TO-252AA	330	mm	m 16mm			2500		
FGP	3440G2	TO-220AB	Tu	Tube N/A				50	50		
Electri Symbol	cal Char	CACTERISTICS T _A = 25° Parameter	1	noted Condit	ions	м	in	Тур	Max	Units	
Off Stat	e Charact	eristics									
BV _{CER}	Collector to E	mitter Breakdown Voltage	$I_{CE} = 2mA, V_{GE} = 0$ $R_{GE} = 1K\Omega,$ $T_{J} = -40$ to $150^{\circ}C$),		37	70	400	430	V	
BV _{CES}	Collector to E	mitter Breakdown Voltage	$I_{CE} = 10mA, V_{GE} = 0V,$ $R_{GE} = 0,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$			39	90	420	450	V	
BV _{ECS}	Emitter to Co	llector Breakdown Voltage	I _{CE} = -20mA, V _{GE} = 0V, T _J = 25°C		2	8	-	-	V		
BV _{GES}	Gate to Emitt	er Breakdown Voltage	I _{GES} = ±2mA		±1	2	±14	-	V		
	Collector to Emitter Leakage Current	V_{CE} = 250V, R_{GE} =1K Ω	1KΩ	T _J = 25°C	-		-	25	μA		
I _{CER}		ů		T _J = 150°C	-		-	1	mA		
I _{ECS}	Emitter to Collector Leakage Current	V _{EC} = 24V,		T _J = 25°C		-	-	1	mA		
		lioter Loanage ourient	T _J		T _J = 150°C	-		-	40		
R ₁	Series Gate I	Resistance				-		120	-	Ω	
R ₂	Gate to Emitt	er Resistance				10	ĸ	-	30K	Ω	

On State Characteristics

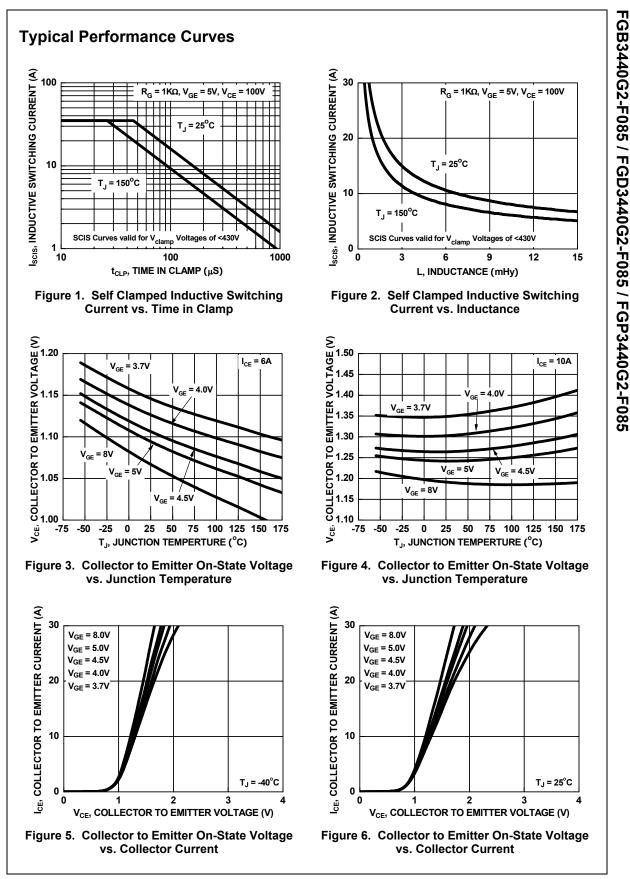
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	$I_{CE} = 6A, V_{GE} = 4V,$	$T_J = 25^{\circ}C$	-	1.1	1.2	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I _{CE} = 10A, V _{GE} = 4.5V,	T _J = 150 ^o C	-	1.3	1.45	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I _{CE} = 15A, V _{GE} = 4.5V,	T _J = 150 ^o C	-	1.6	1.75	V
E _{SCIS}	Self Clamped Inductive Switching	L = 3.0 mHy, VGE = 5V RG = 1KΩ, (Note 1)	TJ = 25°C	-	-	335	mJ

Notes:

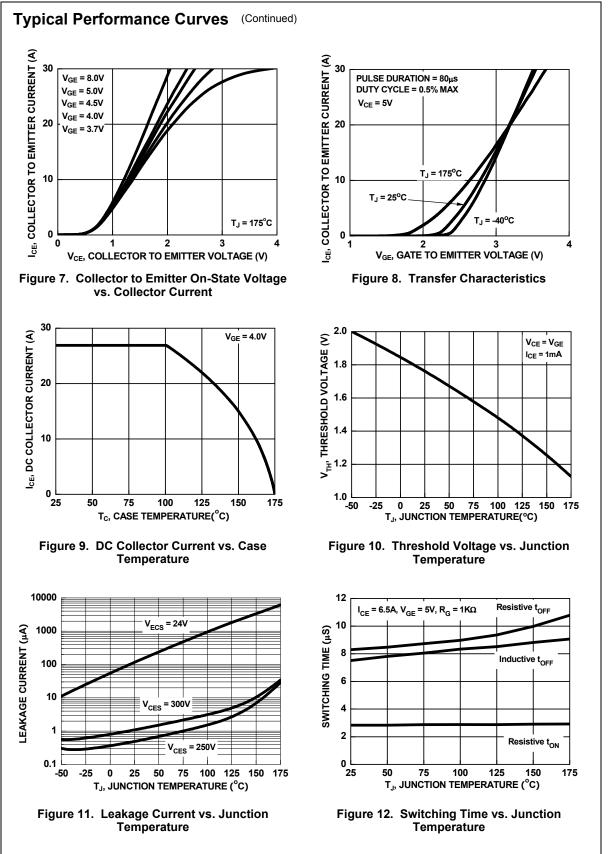
1: Self Clamping Inductive Switching Energy(Escis25) of 335mJ is based on the test conditions that is starting $T_J=25$ °C; L=3mHy, $I_{SCIS}=15A, V_{CC}=100V$ during inductor charging and $V_{CC}=0V$ during the time in clamp . 2: Self Clamping Inductive Switching Energy (Escis150) of 195mJ is based on the test conditions that is starting

2: Self Clamping Inductive Switching Energy (Escis150) of 195mJ is based on the test conditions that is starting T_J =150 °C; L=3mHy, Iscis=11.4A,Vcc=100V during inductor charging and Vcc=0V during the time in clamp.

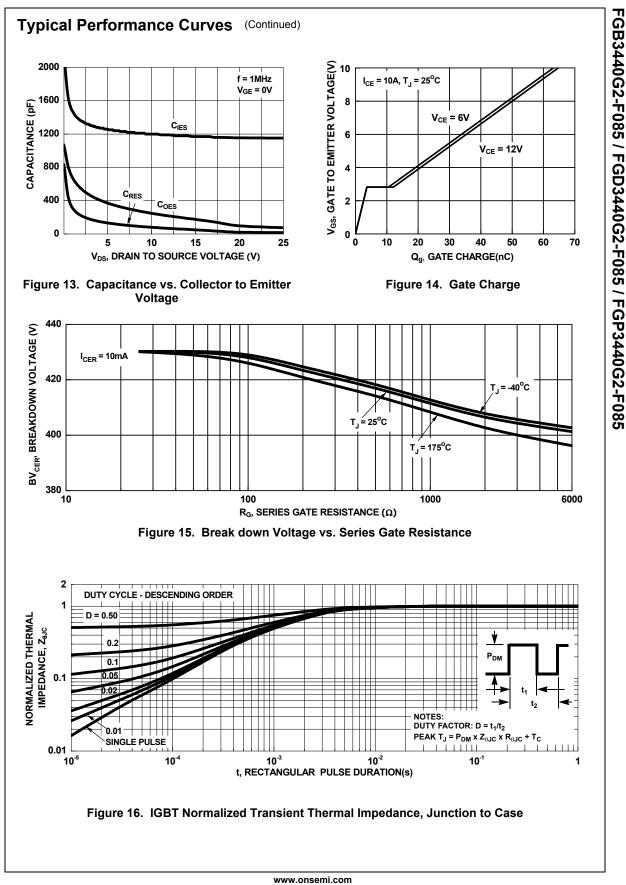
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$Q_{G(ON)}$ G $V_{GE(TH)}$ G V_{GEP} G	Gate Charge			24		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	V _{GE(TH)} G	5		-	24		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	V _{GEP} G	Gate to Emitter Threshold Voltage			24	-	nC
Switching Characteristics $t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -1.04 μs t_{rR} Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -2.07 μs $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -5.315 μs t_{fL} Current Fall Time-Inductive $V_{CE} = 300V, L = 1mH,$ -5.315 μs Thermal Characteristics			I_{CE} = 1mA, V_{CE} = V_{GE} ,				v
Switching Characteristics $t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -1.04 μs t_{rR} Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -2.07 μs $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -5.315 μs t_{fL} Current Fall Time-Inductive $V_{GE} = 5V, R_G = 1K\Omega$ -2.315 μs Thermal Characteristics		Gate to Emitter Plateau Voltage	V _{CE} = 12V, I _{CE} = 10A	 -	2.8	-	V
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Switchin	ng Characteristics					
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	t _{d(ON)R} C	Current Turn-On Delay Time-Resistive		-	1.0	4	μS
$V_{GE}^{a} = 5V, R_{G} = 1K\Omega$ $I_{CE} = 6.5A, T_{J} = 25^{\circ}C,$ Thermal Characteristics		Current Rise Time-Resistive		-	2.0	7	μS
$I_{CE} = 6.5A, T_J = 25^{\circ}C, \qquad - 2.3 15 \mu s$ Thermal Characteristics	t _{d(OFF)L} C	Current Turn-Off Delay Time-Inductive		-	5.3	15	μS
	t _{fL} C	Current Fall Time-Inductive		-	2.3	15	μs
R _{θJC} Thermal Resistance Junction to Case 0.9 °C/W	Thermal	Characteristics					
	R _{0JC} Th	hermal Resistance Junction to Case		-	-	0.9	°C/W
	κ _θ jc 11		<u> </u>	 <u> </u>		0.9	C/W



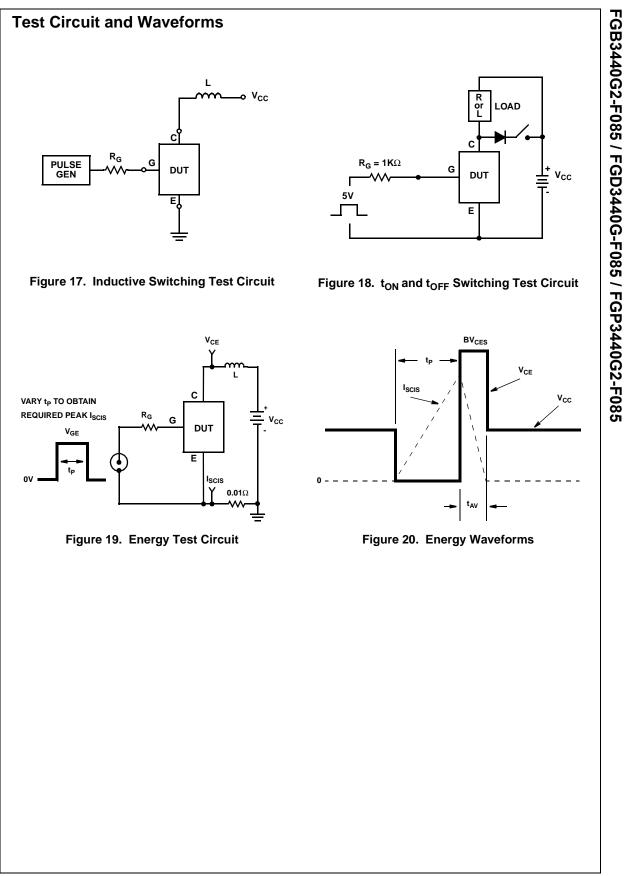
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